

450V N-Channel Power MOSFET



SOP-8

Pin Definition:

1. So 2. G 3. So 4. G

1. Source 1	8. Drain 1
2. Gate 1	7. Drain 1
3. Source 2	6. Drain 2
1 Gate 2	5 Drain 2

PRODUCT SUMMARY

V _{DS} (V)	$R_{DS(on)}(m\Omega)$	I _D (A)
450	4.25 @ V _{GS} =10V	0.5

General Description

The TSM1N45 is N-Channel enhancement mode power field effect transistors are produced using planar DMOS technology process. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand higher energy pulse in the avalanche and commutation mode. There devices are well suited for electronic ballasts base and half bridge configuration.

Features

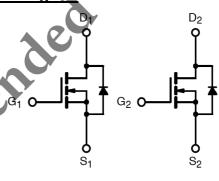
- Low gate charge @ typical 6.5nC
- Low Crss @ typical 6.5pF
- Avalanche energy specified
- Improved dv/dt capability
- Gate-Source Voltage ±50V guaranteed

Ordering Information

Part No.	Package	Packing
TSM1N45DCS RLG	SOP-8	2.5Kpcs / 13" Reel

Note: "G" denotes for Halogen Free

Block Diagram



Dual N-Channel MOSFET

Absolute Maximum Rating (Ta = 25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	450	V
Gate-Source Voltage	V_{GS}	±50	V
Continuous Drain Current	I _D	0.5	А
Pulsed Drain Current (Note 1)	I _{DM}	4	Α
Single Pulse Drain to Source Avalanche Energy (Note 2)	E _{AS}	108	mJ
Avalanche Current (Note 1)	I _{AR}	0.5	А
Repetitive Avalanche Energy (Note 1)	E _{AR}	0.25	mJ
Peak Diode Recovery dv/dt (Note 3)	dv/dt	5.5	V/ns
Maximum Power Dissipation @Ta = 25°C	P _D	0.9	W
Operating Junction and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Thermal Performance

Parameter	Symbol	Limit	Unit
Thermal Resistance - Junction to Ambient	$R\Theta_{JA}$	80	°C/W

Notes: Surface mounted on FR4 board t ≤ 10sec





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Electrical Specifications (Ta=25°C, unless otherwise noted)

Parameter	Conditions	Symbol	Min	Тур	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250uA$	BV _{DSS}	450			V
Drain-Source On-State Resistance	$V_{GS} = 10V, I_D = 0.25A$	R _{DS(ON)}		3.4	4.25	Ω
O . T	$V_{DS} = V_{GS}, I_{D} = 250uA$		2.3	3.0	3.7	V
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \text{mA}$	$V_{GS(TH)}$	3.1	4.2	4.9	
Zero Gate Voltage Drain Current	$V_{DS} = 450V, V_{GS} = 0V$	I _{DSS}			10	uA
Gate Body Leakage	$V_{GS} = \pm 50V, V_{DS} = 0V$	I _{GSS}			±100	nA
Forward Transconductance	$V_{DS} = 50V, I_{D} = 0.25A$	g _{fs}		0.7		S
Diode Forward Voltage	$I_S = 1A$, $V_{GS} = 0V$	V_{SD}			1.5	V
Dynamic						
Total Gate Charge	$V_{DS} = 360V, I_{D} = 0.5A,$	Q_g		6.5		
Gate-Source Charge	$V_{GS} = 10V$	Q_{gs}	7	0.9		nC
Gate-Drain Charge	(Note 4,5)	Q_{gd}	9	3.2		
Input Capacitance	$V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz	Ciss		185		
Output Capacitance		Coss		29		pF
Reverse Transfer Capacitance	1 = 1.000112	C_{rss}		6.5		
Switching						
Turn-On Delay Time	$V_{GS} = 25V, I_D = 0.5A,$	$t_{d(on)}$		7.5		
Turn-On Rise Time	$V_{GS} = 25V, I_D = 0.5A,$ $V_{DS} = 225V, R_G = 25\Omega$	t _r		21		nS
Turn-Off Delay Time	$V_{DS} = 225V, R_G = 25\Omega$ (Note 4,5)	t _{d(off)}		23		113
Turn-Off Fall Time	(Note 4,3)	t _f		36		
Drain-Source Diode Characteristics and Maximum Ratings						
Maximum Continuous Drain-Source D	iode Forward Current	I _S			0.5	Α
Maximum Pulsed Drain-Source Diode	Forward Current	I _{SM}			4.0	Α
Drain-Source Diode Forward Voltage	$V_{GS} = 25V, I_{S} = 0.5A$	V _{SD}			1.4	V
Reverse Recovery Time	$V_{GS} = 25V$, $I_{S} = 0.5A$. $dI_{F}/dt = 100A/\mu S$	t _{rr}		102		nS
Reverse Recovery Charge	(Note 4)	Q_{rr}		0.26		μC

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L=75mH, I_{AS} =1.6A, V_{DD} =50V, R_{G} =25 Ω , Starting T_{J} =25°C 3. $I_{SD} \le 0.5A$, di/dt $\le 300A/\mu S$, $V_{DD} \le BV_{DSS}$, Starting T_{J} =25°C 4. Pulse test: pulse width $\le 300u S$, duty cycle $\le 2\%$ 5. Essentially independent of operating temperature

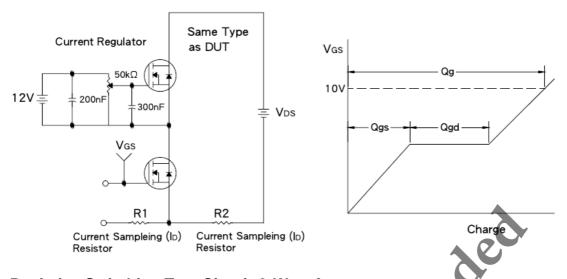
- 6. a) Reference point of the is the drain $R\Theta_{JL}\,lead$
 - b) When mounted on 3"x4.5" FR-4 PCB without any pad copper in a still air environment $(R\Theta_{JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance. $R\Theta_{CA}$ is determined by the user's board design)



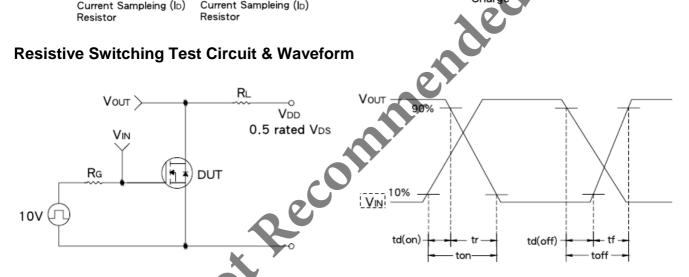
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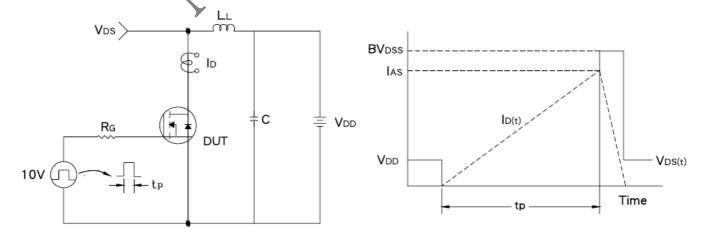
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



E_{AS} Test Circuit & Waveform

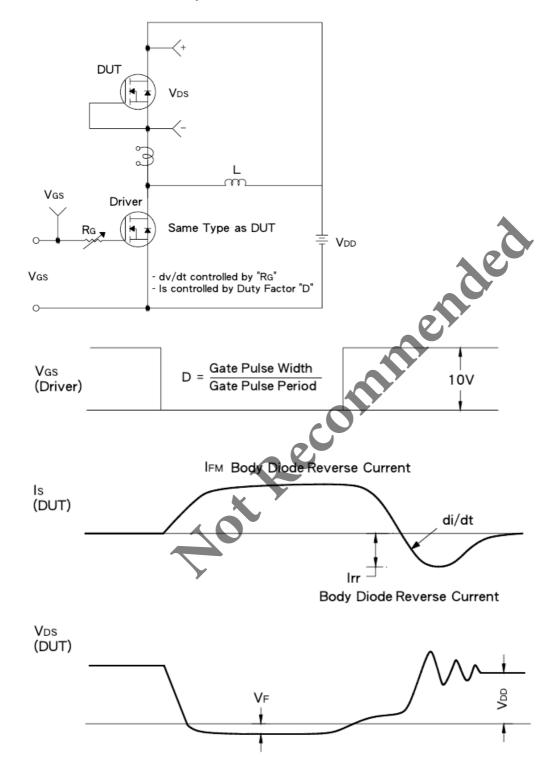




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Diode Reverse Recovery Time Test Circuit & Waveform

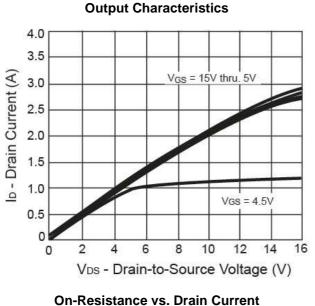


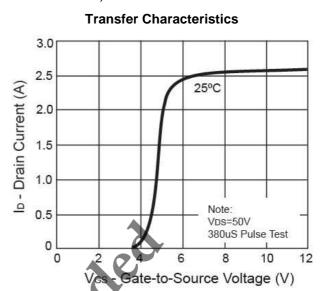


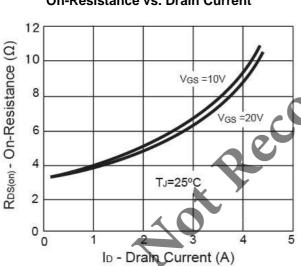
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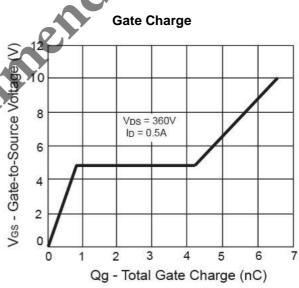


Electrical Characteristics Curve (Ta = 25°C, unless otherwise noted)

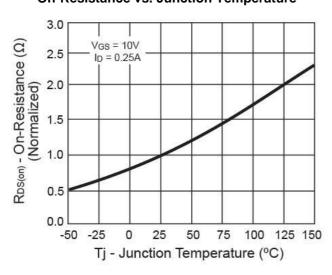




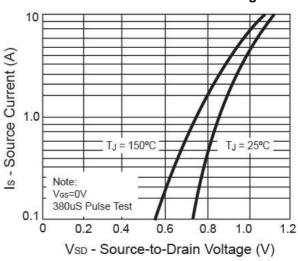








Source-Drain Diode Forward Voltage

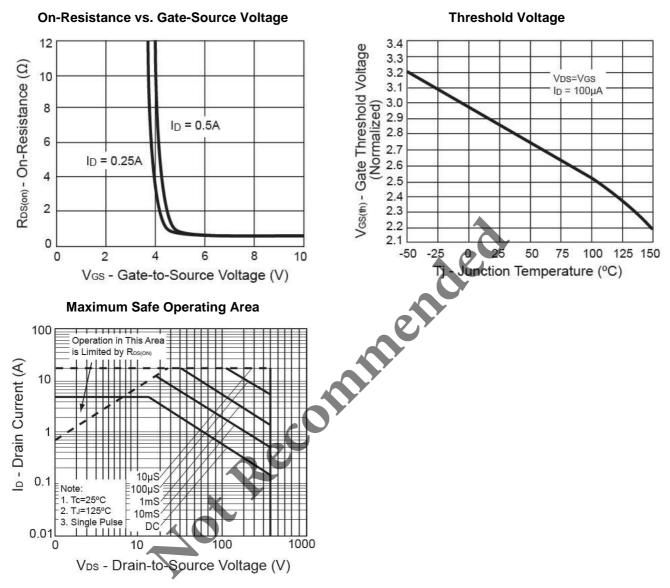




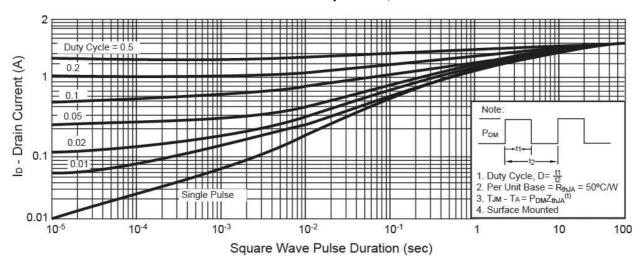
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Normalized Thermal Transient Impedance, Junction-to-Ambient

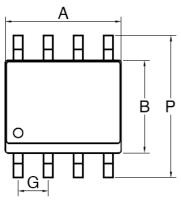




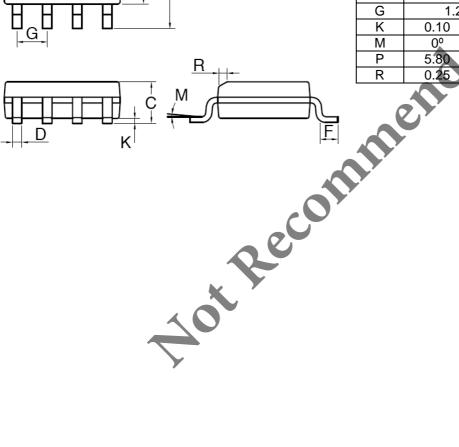
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SOP-8 Mechanical Drawing

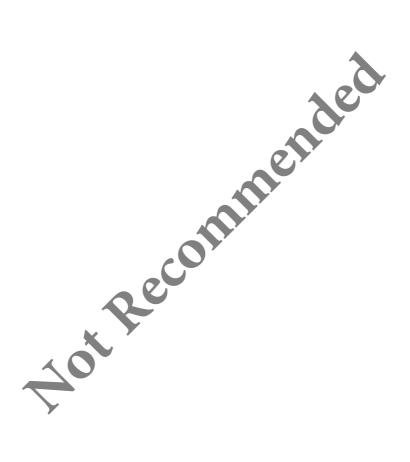


SOP-8 DIMENSION					
DIM	MILLIMETERS		INCHES		
DIIVI	MIN	MAX	MIN	MAX.	
Α	4.80	5.00	0.189	0.196	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.054	0.068	
D	0.35	0.49	0.014	0.019	
F	0.40	1.25	0.016	0.049	
G	1.27	1.27BSC		BSC	
K	0.10	0.25	0.004	0.009	
M	00	7 °	00	7°	
Р	5.80	6.20	0.229	0.244	
R	0.25	0.50	0.010	0.019	





TSM1N45D 450V N-Channel Power MOSFET



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